

TOSHIBA LED LAMP InGaAlP GREEN LIGHT EMISSION

TLGA158P

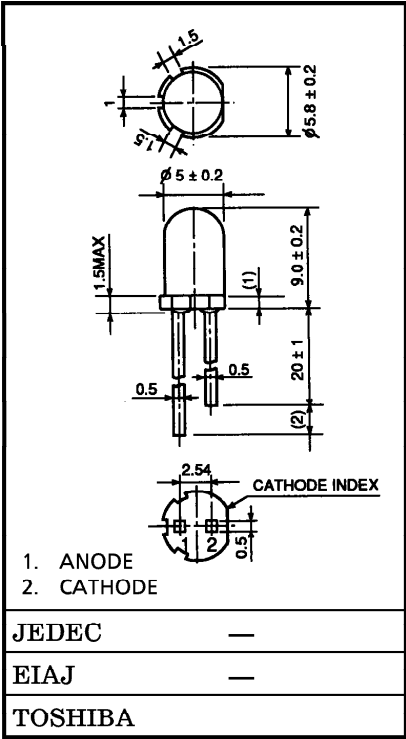
PANEL CIRCUIT INDICATOR

- 5mm DIAMETER (T1-3 / 4)
- InGaAlP GREEN LED
- All Plastic Mold Type.
- Colorless Clear Lens
- Low Drive Current, High Intensity Green Light Emission  
Recommended Forward Current :  $I_F=15\sim20\text{mA}$  (DC)
- All Plastic Molded Lens, Provides an Excellent ON-OFF Contrast Ratio.
- Fast Response Time, Capable of Pulse Operation.
- High Power Luminous Intensity
- Without stand-offs
- APPLICATIONS : Suitable for Outdoor Message Signboard, Safety equipment, etc.

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Forward Current (DC)	$I_F$	50	mA
Reverse Voltage	$V_R$	4	V
Power Dissipation	$P_D$	140	mW
Operating Temperature Range	$T_{opr}$	-30~85	°C
Storage Temperature Range	$T_{stg}$	-40~120	°C

Unit in mm



1. ANODE
2. CATHODE

Weight : 0.31g

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## ELECTRO-OPTICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Forward Voltage		$V_F$	$I_F = 20\text{mA}$	—	2.35	2.8	V
Reverse Current		$I_R$	$V_R = 4\text{V}$	—	—	50	$\mu\text{A}$
Luminous Intensity	TLGA158P	$I_V$	$I_F = 20\text{mA}$ (Note)	153	350	—	mcd
	TLGA158P (PQ)			153	—	736	
Peak Emission Wavelength		$\lambda_p$	$I_F = 20\text{mA}$	—	574	—	nm
Spectral Line Half Width		$\Delta\lambda$	$I_F = 20\text{mA}$	—	11	—	nm
Dominant Wavelength		$\lambda_d$	$I_F = 20\text{mA}$	—	571	—	nm

(Note) Rank selection carried out under next range respectively, although it needs  $\pm 15\%$  additional for guaranteed limits.

P : 180-360mcd, Q : 320-640mcd, R : 560-1120mcd.

## PRECAUTION

Please be careful of the followings

- Soldering temperature : 260°C MAX. Soldering time : 3s MAX.  
(Soldering portion of lead : up to 2mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.

